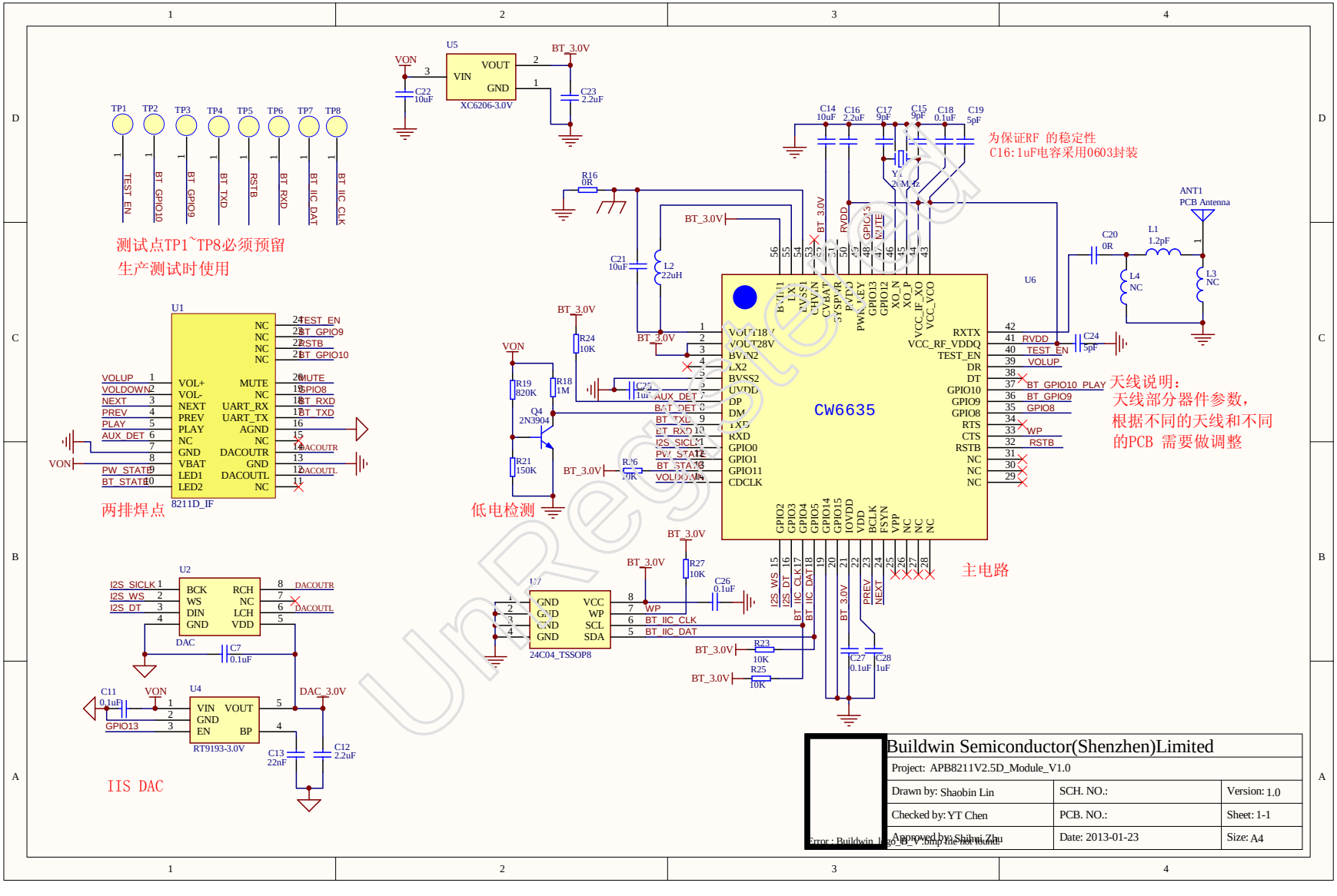
测试点TP1~TP8必须预留
生产测试时使用
两排焊点
IIS DAC
为保证RF 的稳定性
C16:1uF电容采用0603封装
天线说明:
天线部分器件参数,
根据不同的天线和不同
的PCB 需要做调整
低电检测
主电路
CW6635
8211D_IF
XC6206-3.0V
RT9193-3.0V
24C04_TSSOP8
ANT1
PCB Antenna
Buildwin Semiconductor(Shenzhen)Limited
Project: APB8211V2.5D_Module_V1.0
Drawn by: Shaobin Lin
SCH. NO.:
Version: 1.0
Checked by: YT Chen
PCB. NO.:
Sheet: 1-1
Approved by: Shihui Zhu
Date: 2013-01-23
Size: A4